

## Latch, High Voltage Hall-Effect Switch IC (IMC Integrated)

### 1 Product Description

The MT836X-HX family is produced by BCD technology with both high performance and high reliability. The Hall IC internally includes an on-chip Hall voltage generator, a voltage regulator for operation with supply voltage of 3.8V to 60V, temperature compensation circuitry, small-signal amplifier, Hall IC with dynamic offset cancellation system, Schmitt trigger and an open collector output. It also includes a clamp diode at output and reversed power supply protection enhances the robustness of Hall IC.

The MT836X-HX family integrated IMC into the IC, that makes MT836X-HX sensitive to the magnetic flux which parallel to the IC surface.

The Hall IC designed to respond to alternating north and south poles. While the magnetic flux density(B) is larger than operating point (BOP), the output will be turned on (Low), the output is held until the magnetic flux density(B) is lower than releasing point (BRP), then turn off (High).

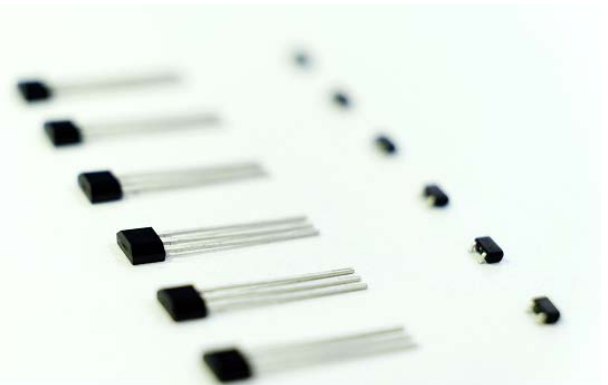
The MT836X-HX family provides a variety of packages to customers: SOT-23 (Thin Outline) for surface mount and flat TO-92 for through-hole mount. All packages are RoHS compliant.

### 2 Features

- AEC-Q100 Automotive Qualified
- BCD Technology
- IMC Technology
- Latch Switch
- 3.8~60V Operating Vcc Range
- -40°C~150°C Operating Temperature
- Package Option:  
Flat TO-92 / SOT-23 (Thin Outline)
- Magnetic Sensitivity Option:  
MT8361-HX (BOP=35Gs, BRP=-35Gs)
- Open-Drain Output
- -20V Reversed Power Supply Protection
- Output Limiting Current Protection
- RoHS Compliant: (EU)2015/863

### 3 Product Overview of MT836X-HX

Part No.	Description
MT836XET-HX	SOT-23 (Thin Outline), tape & reel (3000pcs/bag)
MT836XA-HX	Flat TO-92, bulk packaging (1000pcs/bag)



### 4 Applications

- Automotive, Home appliances,
- Industrial
- Speed Detection
- Magnetic Encoder
- Brushless DC Motor Communication

### 5. Pin Configuration and Functions

	Vcc	Out	GND
SOT-23 (Thin Outline)	1	2	3
Flat TO-92	1	3	2
Description	Power	Output Open-Drain	Ground

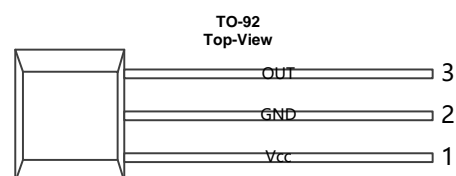
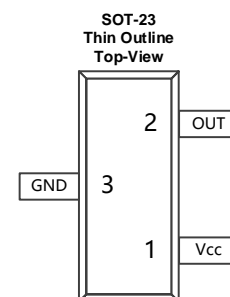


Figure.1 Pin Configuration & Functions

## Table of Contents

1	Product Description.....	1
2	Features.....	1
3	Product Overview of MT836X-HX.....	1
4	Applications.....	1
5	Pin Configuration and Functions.....	1
6	Definition of Switching Function.....	3
7	Function Description.....	3
8	Functional Block Diagram.....	4
9	Electrical and Magnetic Characteristics.....	4
	9.1 Absolute Maximum Ratings.....	4
	9.2 Electrical Specifications.....	5
	9.3 Magnetic Characteristics.....	5
	9.4 ESD Ratings.....	5
	9.5 Characteristic Performance.....	6
	9.6 Typical Output Waveform.....	7
10	Typical Application Circuit.....	7
11	Package Material Information.....	8
	11.1 SOT-23 (Thin Outline) Package Information.....	8
	11.2 Flat TO-92 Package Information.....	9
12	Copy Rights and Disclaimer.....	10

## Reversion History

- 1 Originally Version

## 6 Definition of Switching Function

Figure.2 & Figure.3 shows the device functionality and hysteresis

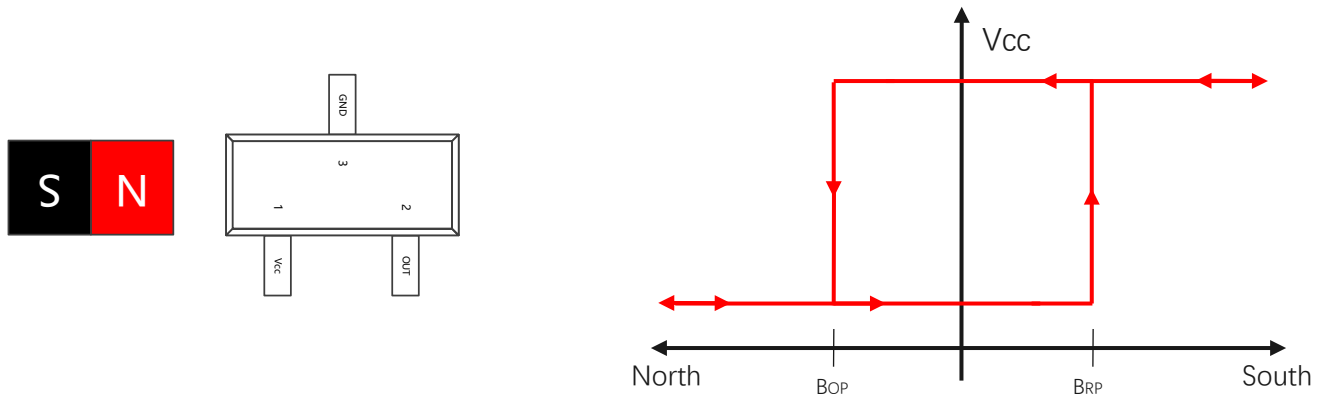


Figure.2 Switching Function of SOT-23 (Thin Outline)

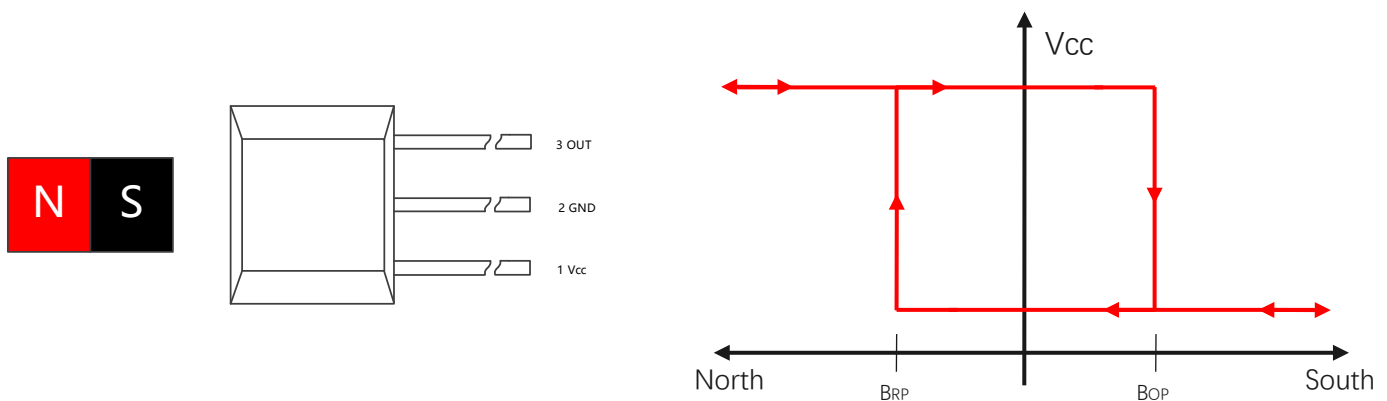


Figure.3 Switching Function of Flat TO-92

## 7 Function Description

**B<sub>OP</sub>:** Operating Point, Magnetic flux density applied on the branded side of the package which turns the output driver ON ( $V_{OUT}=Low$ )

**B<sub>RP</sub>:** Releasing Point, Magnetic flux density applied on the branded side of the package which turns the output driver OFF ( $V_{OUT}=High$ )

**B<sub>HYST</sub>:** Hysteresis Window,  $|B_{OP} - B_{RP}|$

Devices that have a lower magnetic threshold ( $V_{OUT}=High$ ) detect magnets at a farther distance. Higher thresholds ( $V_{OUT}=Low$ ) generally require a closer distance or larger magnet.

## 8 Functional Block Diagram

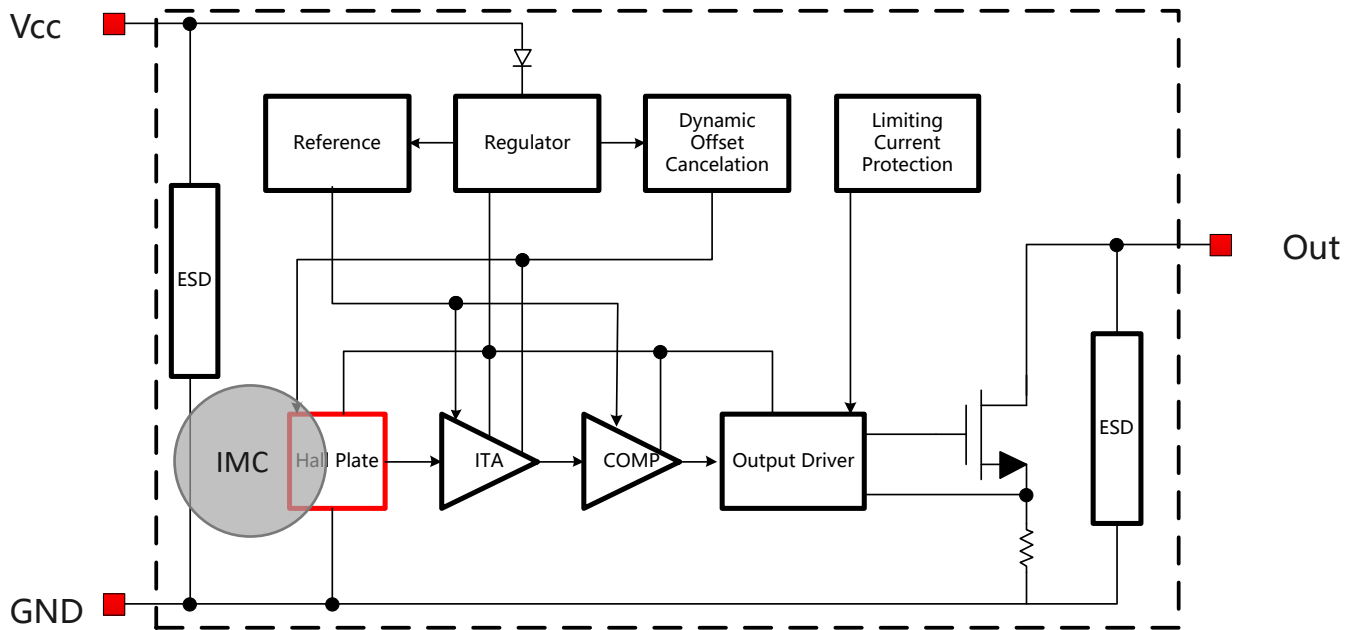


Figure.4 Functional Block Diagram

## 9 Electrical and Magnetic Characteristics

### 9.1 Absolute Maximum Ratings

Absolute maximum ratings are limited values to be applied individually, and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.

Symbol	Parameters	Min	Max	Units
V <sub>CC</sub>	Supply Voltage	-	65	V
V <sub>RCC</sub>	Reverse Battery Voltage	-20	-	V
V <sub>OUT</sub>	Output Voltage	-	65	V
I <sub>OUT</sub>	Continuous Output Current	-	40	mA
T <sub>A</sub>	Operating Ambient Temperature	-40	150	°C
T <sub>S</sub>	Storage Temperature	-50	150	°C
T <sub>J</sub>	Junction Temperature	-	165	°C
B	Magnetic Flux Density	No Limit		Gs

## 9.2 Electrical Specifications

At  $T_A = -40 \sim 150 \text{ }^\circ\text{C}$ ,  $V_{CC} = 3.8\text{V} \sim 60\text{V}$  (unless otherwise specified)

Symbol	Parameters	Test Condition	Min	Typ	Max	Unit
$V_{CC}$	Supply Voltage	Operating	3.8	-	60	V
$I_{CC}$	Supply Current	$B < B_{RP}$	-	4	6	mA
$I_{OCP}$	Short Circuit Protection Current	$B > B_{OP}$ , $V_{OUT} = V_{CC}$	-	50	-	mA
$V_{DSON}$	Output Saturation Voltage	$I_{OUT} = 15\text{mA}$ , $B > B_{OP}$	-	-	0.4	V
$I_{OFF}$	Output Leakage Current	$V_{OUT} = 60\text{V}$	-	-	10	$\mu\text{A}$
$T_R$	Output Rise Time	$R_L = 1\text{K}\Omega$ , $C_L = 20\text{pF}$	-	-	1.0	$\mu\text{s}$
$T_F$	Output Fall Time	$R_L = 1\text{K}\Omega$ , $C_L = 20\text{pF}$	-	-	1.0	$\mu\text{s}$
$T_{PO}$	Power on Time	$dV_{CC}/dt > 5\text{V}/\mu\text{s}$ $B > B_{OP(MAX)}$	-	-	10	$\mu\text{s}$
$F_C$	Chopping Frequency		-	800	-	KHz
$F_S$	Sampling Frequency		-	200	-	KHz
$R_{TH}$	Thermal Resistance of SOT-23 (Thin Outline)		-	301	-	$^\circ\text{C}/\text{W}$
	Thermal Resistance of Flat TO-92		-	230	-	$^\circ\text{C}/\text{W}$

## 9.3 Magnetic Characteristics

At  $V_{CC} = 3.8\text{V} \sim 60\text{V}$  (unless otherwise specified)

Part No.	Symbol	Min	Typ	Max	Unit
MT8361-HX Series	$B_{OP}$ , $T_A = 25^\circ\text{C}$	20	35	50	Gs
	$B_{RP}$ , $T_A = 25^\circ\text{C}$	-50	-35	-20	Gs
	$B_{HYST}$ , $T_A = 25^\circ\text{C}$	40	70	100	Gs

## 9.4 ESD Ratings

Symbol	Reference	Values	Unit
$V_{ESD}$	Human-body model (HBM)	AEC-Q100-002	Class II Grade
	Charged-device model (CDM)	AEC-Q100-011	Class C6 Grade

### 9.5 Characteristic Performance

At  $V_{CC}=5V$

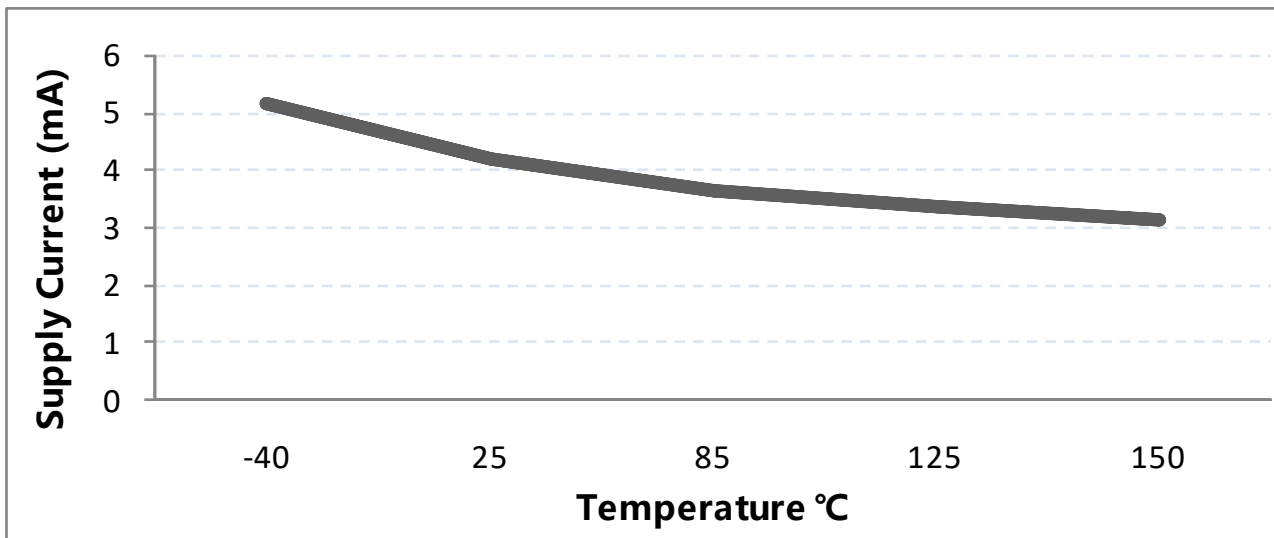


Figure.5 Supply Current vs. Temperature

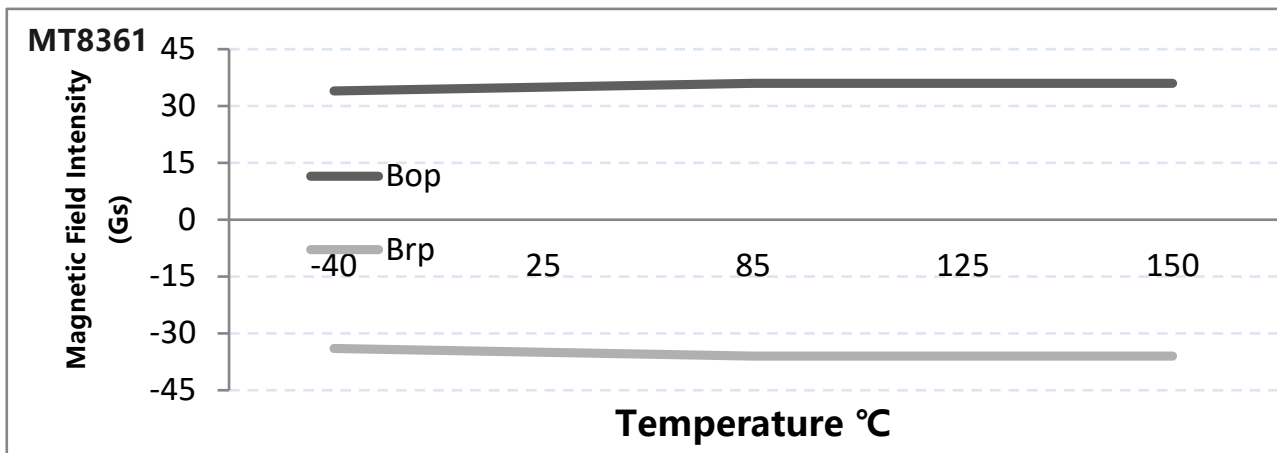


Figure.6 Magnetic Characteristics vs. Temperature (BOP & BRP)

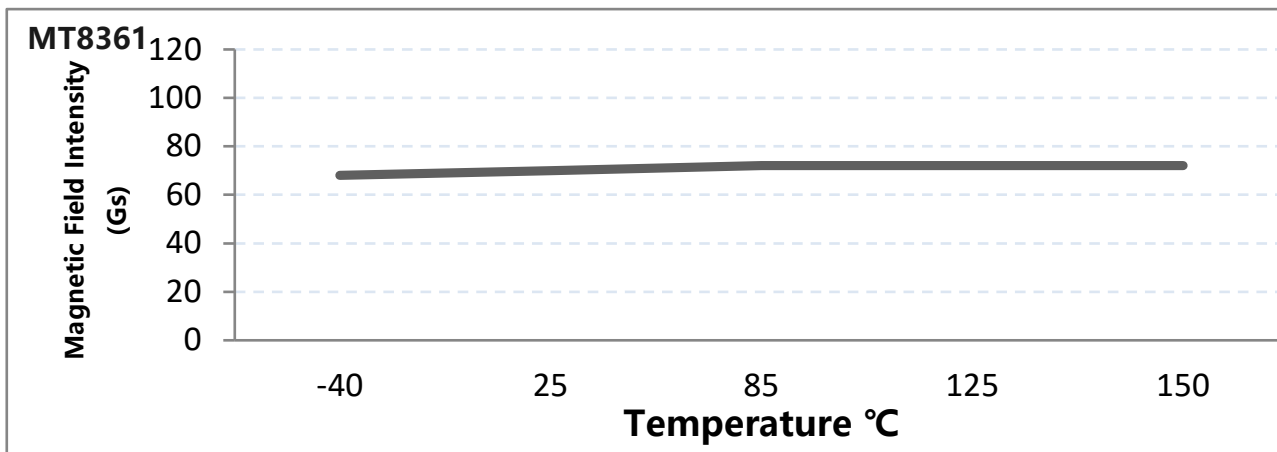


Figure.7 Magnetic Characteristics vs. Temperature (BHYST)

### 9.6 Typical Output Waveform

MT8361ET-HX as example

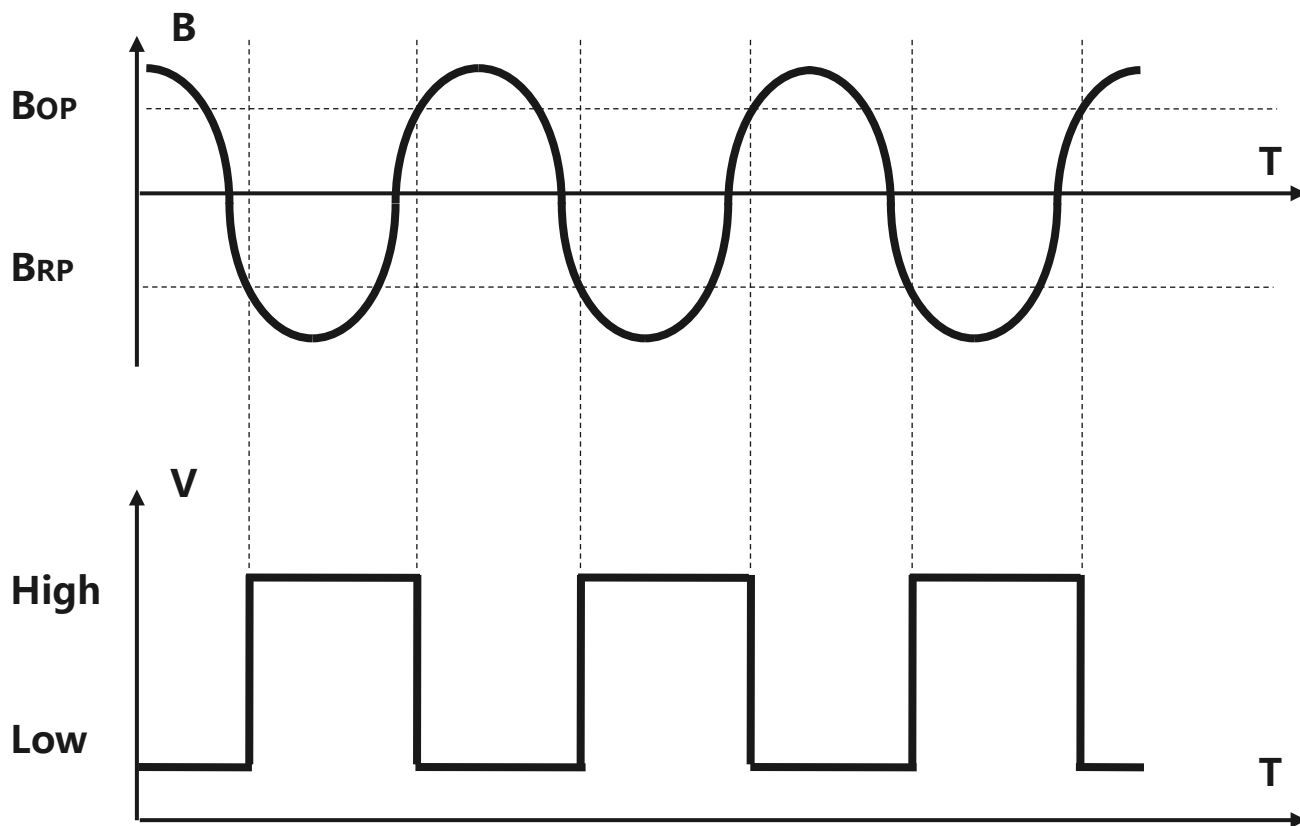


Figure.8 Digital Output vs. Magnetic Flux Density

### 10 Typical Application Circuit

MT8361ET-HX as example

Note: Recommended value for  $R_L$  is 1KOhms to 10KOhms

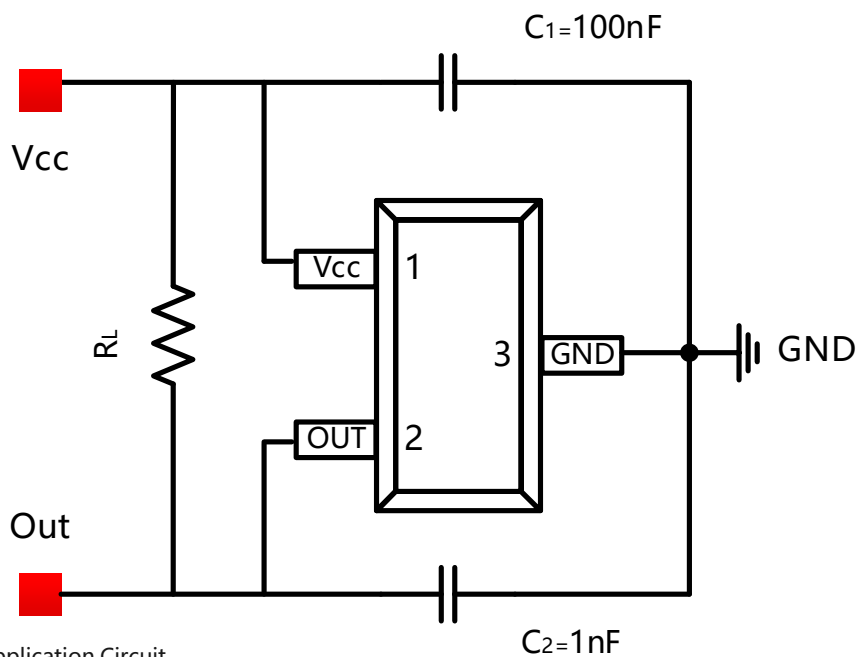


Figure.9 Typical Application Circuit

11 Package Material Information (For Reference Only – Not for Tooling Use)

11.1 SOT-23 (Thin Outline) Package Information

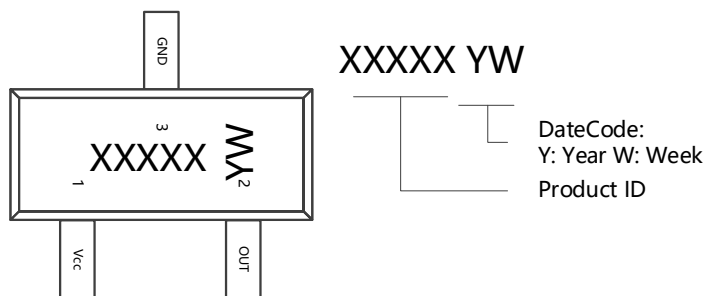


Figure.10 SOT-23 (Thin Outline) Chip Marking Spec

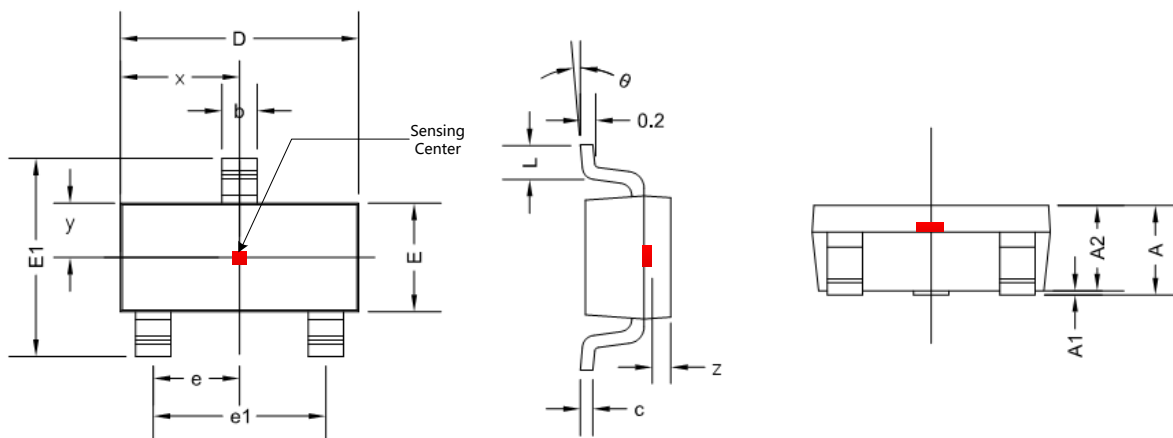


Figure.11 SOT-23 (Thin Outline) Package Drawing

Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.100	0.035	0.043
b	0.300	0.500	0.012	0.020
c	0.132	0.202	0.005	0.008
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0 °	8 °	0 °	8 °
x	1.450 TYP		0.057 TYP	
y	0.650 TYP		0.026 TYP	
z	0.325 TYP		0.013 TYP	



## 11.2 Flat TO-92 Package Information

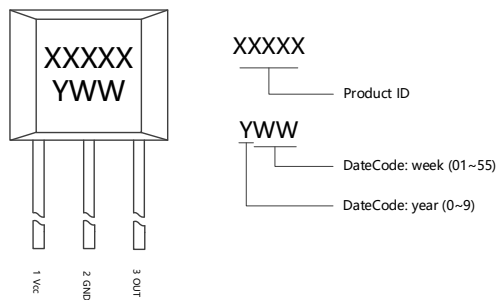


Figure.12 Flat TO-92 Chip Marking Spec

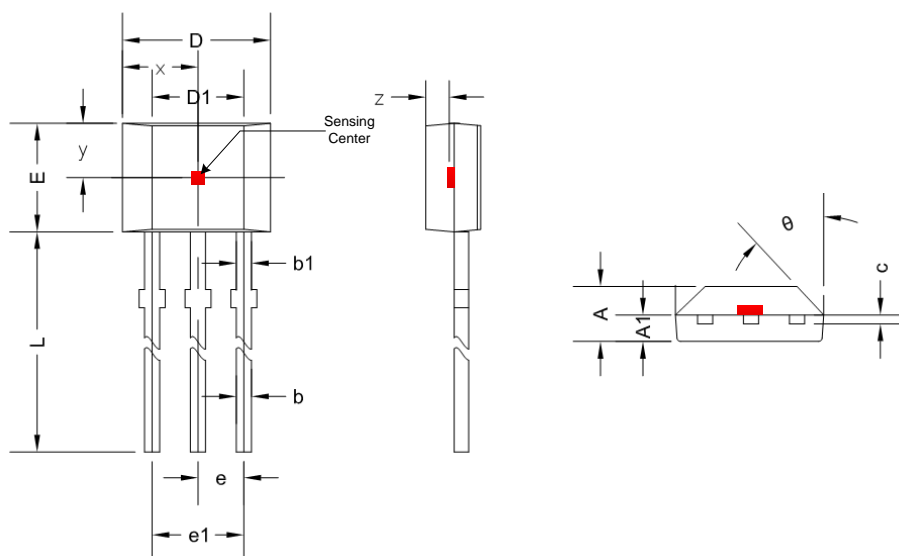


Figure.13 Flat TO-92 Package Drawing

Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	1.420	1.620	0.056	0.064
A1	0.660	0.910	0.026	0.036
b	0.330	0.560	0.013	0.022
b1	0.400	0.510	0.016	0.020
c	0.330	0.510	0.013	0.020
D	3.900	4.200	0.154	0.165
D1	2.280	2.680	0.090	0.106
E	2.900	3.280	0.114	0.128
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	13.500	16.200	0.531	0.638
$\theta$	45 ° TYP		45 ° TYP	
x	2.025 TYP		0.080 TYP	
y	1.545 TYP		0.061 TYP	
z	0.500 TYP		0.020 TYP	

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